EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L2	1	10/695249	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/01/27 09:50
L4	28	("20020175424"|"20040157433"|"6022808"|"6022808"|"6100195"|"6147408"|"6291082"|"6291082"|"6444567"|"6444567"|"6479389"|"6551872"|"6624075"|"6696761"|"6800554"|"6924234").PN.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/01/27 10:21
L5	152	("20020175424"|"20040157433"|"6022808"|"6022808"|"6100195"|"6147408"|"6291082"|"6291082"|"6444567"|"6444567"|"6479389"|"6551872"|"6624075"|"6696761"|"6800554"|"6924234")	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/01/27 10:19
L6	12800	438/637-638,672-673,700,618-624, 687.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/01/27 10:22
L8	5858	6 and copper	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/01/27 10:23
L9	4664	8 and oxide	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/01/27 10:23
L10	4437	9 and etch$3	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/01/27 10:24

L11	1770	9 and (plating electroless)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/01/27 10:25
L12	1233	10 and acid$3	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/01/27 10:38
L13	421	12 and (metal with diffus$4)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/01/27 10:41
L16	421	13 and (metal with diffus$4)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/01/27 10:42
L17	27	16 and (metal with noble)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/01/27 10:42
L18	0	(conductive near3 path with substrate and first adj material and second adj material and facilitating with diffusion and metal with copper and low adj solubility and oxide with etching with acidic and planarizing with comductive with path).clm.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/01/27 10:43